

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode

Features

- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Part Number	Package	Marking
E4M0025075K1	TO-247-4L	E4M0025075K1

Maximum Ratings (T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V_{DSmax}	Drain - Source Voltage		750	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
I			80		Fig. 19 Note: 2
I _D	Continuous Drain Current, V _{GS} = 15 V	59			
I _{D(pulse)}	Pulsed Drain Current, Pulse width t_P limited by T_{jmax}	251	А	Fig. 22	
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$			W	Fig. 20 Note: 2
T_{J} , T_{stg}	Operating Junction and Storage Temperature		-55 to +175	°C	
Τ _L	Solder Temperature, 1.6mm (0.063") from case for 10s		260	°C	
M_{d}	Mounting Torque , M3 or 6-32 screw			Nm lbf-in	

Note (1): Recommended turn off / turn on gate voltage V $_{_{\rm GS}}$ - 4V...0V / +15V

Note (2): Verified by design

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V _{(BR)DSS}	Drain-Source Breakdown Voltage	750		1	V	V _{GS} = 0 V, I _D = 100 μA	1
V	Cata Thread and Valtage	1.8	2.6	3.8	V	V _{DS} = V _{GS} , I _D = 9.22 mA	Fig. 11
$V_{\text{GS(th)}}$	Gate Threshold Voltage		2.1		V	V_{DS} = $V_{\text{GS}},I_{\text{D}}$ = 9.22 mA, T_{J} = 175°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 750 \text{ V}, V_{GS} = 0 \text{ V}$	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
R _{DS(on)}	Drain-Source On-State Resistance		25	34	mΩ	V _{GS} = 15 V, I _D = 33.5 A	Fig. 4,
03(01)			35			V _{GS} = 15 V, I _D = 33.5 A, T _J = 175°C	5, 6
g fs	Transconductance		24	ļ	s	V _{DS} = 20 V, I _{DS} = 33.5 A	Fig. 7
-			18			V _{DS} = 20 V, I _{DS} = 33.5 A, T _J = 175°C	
C _{iss}	Input Capacitance		3055				
C_{oss}	Output Capacitance		158		pF	V_{GS} = 0 V, V_{DS} = 0V to 500 V	Fig. 17, 18
C_{rss}	Reverse Transfer Capacitance		16			F = 100 kHz	
Eoss	Coss Stored Energy		23		μJ	V _{AC} = 25 mV	Fig. 16
$C_{o\left(er\right) }$	Effective Output Capacitance (Energy Related)		201		pF	V _{GS} = 0 V, V _{DS} = 0 500V	Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		291		pF		
Eon	Turn-On Switching Energy (External Diode)		144			V_{DS} = 500 V, V_{GS} = -4 V/15 V, I_{D} = 33.5 A,	Fig. 26, 28
EOFF	Turn Off Switching Energy (External Diode)		103		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 µH, T _J = 175°C FWD = External SiC DIODE	
Eon	Turn-On Switching Energy (Body Diode FWD)		224			V_{DS} = 500 V, V_{GS} = -4 V/15 V, I_{D} = 33.5 A,	Fig. 26, 28
EOFF	Turn-Off Switching Energy (Body Diode FWD)		92		μJ	$R_{G(ext)} = 2.5 $ Ω, L= 59 μH, T _J = 175°C FWD = Internal Body Diode	
t _{d(on)}	Turn-On Delay Time		12				
tr	Rise Time		18]	V_{DD} = 500 V, V_{GS} = -4 V/15 V I _D = 33.5 A, $R_{G(ext)}$ = 2.5 Ω,	Fig. 27, 28
$t_{\text{d(off)}}$	Turn-Off Delay Time		31		ns	Timing relative to V_{DS}	
t _f	Fall Time		10]		
$R_{G(int)}$	Internal Gate Resistance		2.0		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		33			V _{DS} = 500 V, V _{GS} = -4 V/15 V	
Q_{gd}	Gate to Drain Charge		40	1	nC	I _D = 33.5 A	Fig. 12
Qg	Total Gate Charge		119			Per IEC60747-8-4 pg 21	

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V $C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V



Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V	V _{SD} Diode Forward Voltage	4.8		V	$V_{_{\rm GS}}$ = -4 V, I $_{_{\rm SD}}$ = 16.8 A, T $_{_{\rm J}}$ = 25 °C	Fig. 8,
V _{SD}		4.2		V	V _{gs} = -4 V, I _{sp} = 16.8 A, T _J = 175 °C	9,10
Is	Continuous Diode Forward Current		47	А	V _{gs} = -4 V, T _c = 25°C	
I _{S, pulse}	Diode pulse Current		251	А	$V_{_{GS}}$ = -4 V, pulse width $t_{_{P}}$ limited by $T_{_{jmax}}$	
t _{rr}	Reverse Recover time	29		ns	V _{GS} = -4 V, I _{SD} = 33.5 A, V _R = 500 V dif/dt = 2185 A/μs, Τ _J = 175 °C	
Q _{rr}	Reverse Recovery Charge	372		nC		
I _{rrm}	Peak Reverse Recovery Current	23		А		
t _{rr}	Reverse Recover time	20		ns		
Q _{rr}	Reverse Recovery Charge	601		nC	V _{GS} = -4 V, I _{SD} = 33.5 A, V _R = 500 V dif/dt = 6235 A/μs, Τ ₁ = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	52		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
R _{eJC}	Thermal Resistance from Junction to Case	0.45	0.57	°C/W		Fig. 21





Figure 1. Output Characteristics T_J = -55 °C



Figure 3. Output Characteristics T_J = 175 °C







Figure 2. Output Characteristics T_J = 25 °C







Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics

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Figure 13. 3rd Quadrant Characteristic at -55 °C



Figure 15. 3rd Quadrant Characteristic at 175 °C







Figure 14. 3rd Quadrant Characteristic at 25 °C



Figure 16. Output Capacitor Stored Energy



Figure 18. Capacitances vs. Drain-Source Voltage (0 - 750V)

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Typical Performance



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Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}



Figure 27. Switching Times vs. R_{G(ext)}



Figure 26. Clamped Inductive Switching Energy vs. Temperature



Figure 28. Switching Times Definition

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Test Circuit Schematic





Figure 29. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions





SYMBOL	MIN (mm)	MAX (mm)		
A	4.83	5.21		
A1	2.22	2.6		
A2	1.91	2.16		
b	1.10	1.30		
b1	0.65	0.79		
b3	1.34	1.44		
b5	0.74	1.14		
с	0.55	0.68		
D	20.76	21.14		
D1	16.25	17.65		
D2	2.95	3.35		
E	15.75	16.13		
E1	13.1	14.15		
E2	3.68	5.10		
E3	1.00	1.90		
E4	12.38	13.43		
E5	14.65	15.05		
e1	5.08 BSC			
e2	2.79	BSC		
e3	2.54	BSC		
L	19.72	20.32		
L1	3.87	4.47		
ØP	3.51	3.65		
Q	5.49	6.00		
S	6.04	6.30		
Т	17.5°	REF.		
W	3.5°	REF.		
X	4° F	REF.		

1	DRAIN
2	SOURCE
3	DRIVER SOURCE
4	GATE
5	DRAIN

NOTE:

- 1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
- 2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS



Recommended Solder Pad Layout

All dimensions in mm



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Revision history

Document Version	Date of release	Descriptiion of changes
1.0	January-2024	Initial datasheet
2	January - 2025	Legal Disclaimer Updated

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